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Attorney Docket No. SHG-046P2

## **DECLARATION, POWER OF ATTORNEY, AND PETITION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

subject matter which is claimed and for which a patent is sought on the invention entitled SEMICONDUCTOR DEVICE				
the specification	f which (check one below):			
()	is attached hereto.			
()	was filed on as Application Serial or Express Mail No, and was amende (if applicable).			
(X)	was filed on <u>25/August/2005</u> as PCT International Application			

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

(if any).

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations '1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, '119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application	on(s)		Priority Claimed?		
2004-289248 (Number)	Japan (Country)	30/09/2004 Day/Month/Year Filed	(X) Yes () No		
(Number)	(Country)	Day/Month/Year Filed	() Yes() No		
(Number)	(Country)	Day/Month/Year Filed	( ) Yes ( ) No		
matter of each of the cla application in the manne '112, I acknowledge the Office all information knowledge of Federal Regula	aims of this application er provided by the first ne duty to disclose to nown to me to be mate ations '1.56, which be	listed below and, insofance is not disclosed in the property paragraph of Title 35, Unthe United States Patenterial to patentability as decame available between international filing date of	rior United States ited States Code, t and Trademark efined in Title 37, the filing date of		
(Serial No.)	(Filing Date)	(Status: Patented, Pen	ding, or Abandoned)		
(Serial No.)	(Filing Date)	(Status: Patented, Pen	ding, or Abandoned)		
(Serial No.)	(Filing Date)	(Status: Patented, Pen	ding, or Abandoned)		
		of Wood, Herron & Eva OH 45202-2917, under o			

26,875, my attorneys, with full power of substitute and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

Address all correspondence and telephone calls to:

Thomas W. Flynn Wood, Herron & Evans, LLP 2700 Carew Tower 441 Vine Street Cincinnati, OH 45202 Customer Number 26,875 Telephone (513) 241-2324

Wherefore I pray that Letters Patent be granted to me for the invention or discovery described and claimed in the foregoing specification and claims, and I hereby subscribe my name to the foregoing specification and claims, declaration, power of attorney, and this petition.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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